# 2.5V Drive Nch+SBD MOSFET **US6U37**

#### Structure

Silicon N-channel MOSFET/ Schottky barrier diode

#### ● Features

- 1) Nch MOSFET and schottky barrier diode are put in TUMT6 package.
- 2) High-speed switching, Low On-resistance.
- 3) Low voltage drive (2.5V drive).
- 4) Built-in Low VF schottky barrier diode.

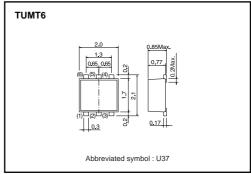
## Applications

Switching

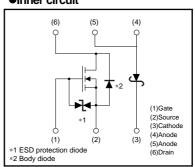
#### Package specifications

	Package	Taping
Туре	Code	TR
	Basic ordering unit (pieces)	3000
US6U37		0

## ●Dimensions (Unit:mm)



#### •Inner circuit



#### ● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter	Symbol	Limits	Unit	
Drain-source voltage		V <sub>DSS</sub>	30	V
Gate-source voltage	Vgss	±12	V	
Danie accept	Continuous	ΙD	±1.5	Α
Drain current	Pulsed	I <sub>DP</sub> *1	±6.0	Α
Source current	Continuous	Is	0.6	А
(Body diode)	Pulsed	I <sub>SP</sub> *1	6.0	Α
Channel temperature		Tch	150	°C
Power dissipation		P <sub>D</sub> *2	0.7	W / ELEMENT

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1% \*2 Mounted on a ceramic board

#### <Di>

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Parameter	Symbol	Limits	Unit	
Repetitive peak reverse voltage	V <sub>RM</sub>	25	V	
Reverse voltage	VR	20	V	
Forward current	lF	0.7	A	
Forward current surge peak	IFSM *1	10	A	
Junction temperature	Tj	150	°C	
Power dissination	Pn *2	0.5	W / FI FMFNT	

<sup>\*1 60</sup>Hz • 1cycle \*2 Mounted on ceramic board

## **Transistors**

## <MOSFET and Di>

Parameter	Symbol	Limits	Unit	
Power dissipation	P <sub>D</sub> *1	1.0	W / TOTAL	
Range of storage temperature	Tstg	-55 to +150	°C	

<sup>\*1</sup> Mounted on a ceramic board

## ●Electrical characteristics (Ta=25°C)

## <MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	_	±10	μΑ	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V(BR) DSS	30	_	_	V	ID= 1mA, VGS=0V
Zero gate voltage drain current	IDSS	-	_	1	μΑ	V <sub>DS</sub> = 30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	0.5	_	1.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Otatia dania annua an atata		-	170	240	mΩ	I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 4.5V
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	-	180	250	mΩ	I <sub>D</sub> = 1.5A, V <sub>G</sub> S= 4V
- I e si stati ce		-	240	340	mΩ	ID= 1.5A, VGS= 2.5V
Forward transfer admittance	Y <sub>fs</sub>   *	1.5	_	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1.5A
Input capacitance	Ciss	_	80	_	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	14	_	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	12	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	7	_	ns	V <sub>DD</sub> ≒ 15V
Rise time	tr *	_	9	_	ns	ID= 0.75A   VGS= 4.5V
Turn-off delay time	t <sub>d (off)</sub> *	_	15	_	ns	VGS= 4.5V RL≒ 20Ω
Fall time	t <sub>f</sub> *	_	6	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	-	1.6	2.2	nC	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 4.5V
Gate-source charge	Q <sub>gs</sub> *	-	0.5	_	nC	I <sub>D</sub> = 1.5A
Gate-drain charge	Q <sub>gd</sub> *	_	0.3	_	nC	R <sub>L</sub> ≒10Ω, R <sub>G</sub> =10Ω

<sup>\*</sup>Pulsed

## <Body diode characteristics (Source-drain)>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VsD	_	_	1.2	V	I <sub>S</sub> = 0.6A, V <sub>GS</sub> =0V

## <Di>

\DIZ						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	-	_	0.49	V	I <sub>F</sub> = 0.7A
Reverse current	lR	_	_	200	μA	V <sub>R</sub> = 20V



#### •Electrical characteristics curves

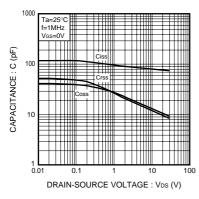


Fig.1 Typical Capacitance vs. Drain-Source Voltage

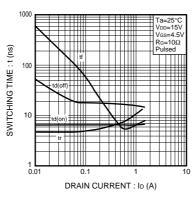


Fig.2 Switching Characteristics

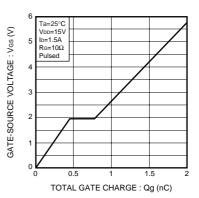


Fig.3 Dynamic Input Characteristics

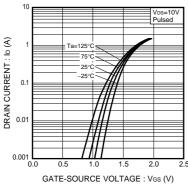


Fig.4 Typical Transfer Characteristics

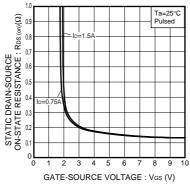


Fig.5 Static Drain-Source On-State Resistance vs. Gate source Voltage

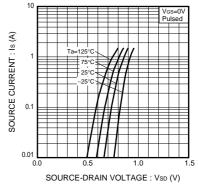


Fig.6 Source Current vs. Source-Drain Voltage

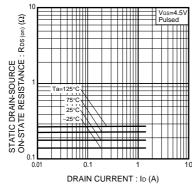


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current ( I )

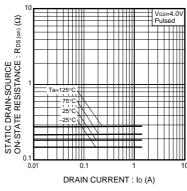


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current ( II )

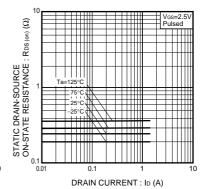
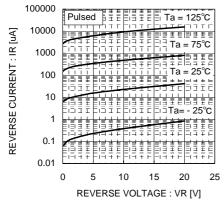


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current ( III )



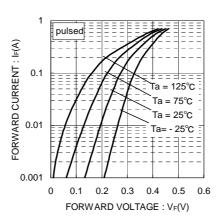


Fig.10 Reverse Current vs. Reverse

Fig.11 Forward Current vs. Forward Voltage

## ●Measurement circuit

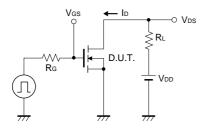


Fig.12 Switching Time Test Circuit

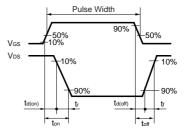


Fig.13 Switching Time Waveforms

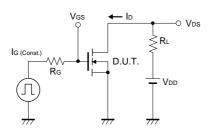


Fig.14 Gate Charge Measurement Circuit

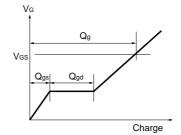


Fig.15 Gate Charge Waveform

#### ●Notice

- 1. SBD has a large reverse leak current compared to other type of diode. Therefore; it would raise a junction temperature, and increase a reverse power loss. Further rise of inside temperature would cause a thermal runaway.
  This built-in SBD has low V<sub>F</sub> characteristics and therefore, higher leak current. Please consider enough the surrounding temperature, generating heat of MOSFET and the reverse current.
- 2. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.





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